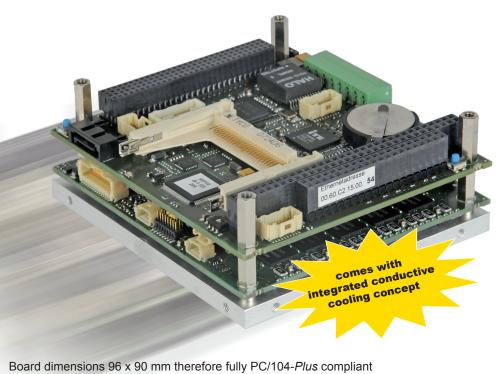
PIP8/PIP9/PIP10/PIP11

CPU Boards for extreme environments

General Description

The MIP10 family offers highly integrated Embedded CPU Boards on a footprint smaller than two credit cards. It is designed for fanless operation, powerful, robust and based on the Intel Centrino Mobile Technology. Choose from 4 different, long term available, low power Intel CPUs. On-board integrated is next to numerous standard features, SATA, onboard ECC RAM as well as Gigabit Ethernet. The boards represents a distinguish solution for today's demanding industrial needs and x86 upgrade. The products are easy expandable over PC/104 as well as PC/104-Plus. The MIP10 family is designed from scratch to operate under extreme and normal conditions without the need of fans or derating and throttling. The boards are rugged enough to be used in any application.



MIP10 Specialities

are the extreme small footprint, the low power consumption and the conductive cooling concept as well as its high functionality. The footprint is fully according to the PC/104-*Plus* specification without using the I/O overhang areas. The boards are 100% PC compatible and in addition offer several industrial features. Other distinguish features are:

- Soldered low power CPU
- Soldered ECC RAM
- Lockable headers
- CF-Slot
- Gigabit Ethernet
- Long-term availability

These Features make

the MIP10 family boards to the ideal solution for any application where a high performance PC with a low power consumption and long-term availability is desired. The products are used in applications like vision, transportation systems, telecom as well as in industrial applications. Because of its size the boards are ideal to upgrade existing x86 PC/104 boards.

Example of the series of the s



Technical Features

Board Key Data			
Processor:	Intel Low Power Embedded:		all from the Embedded IA-Roadmap
MIP11	Pentium-M [®] CPU, 1.8GHz, 2M L2 cache		Pentium-M [®] CPUs support Intel SpeedStep
MIP10	Pentium-M [®] CPU, 1.4GHz, 2M L2 cache		
MIP9	Celeron-M [®] CPU, 1.0GH		
MIP8	Celeron-M [®] CPU, 600 N		
Chip Set	Intel 855GME & 6300ESB		400MHz Frontside Bus
BIOS	1MB Flash EEPROM, easy BIOS update		MPL engineered BIOS (General Software)
Memory	Up to 1.25Gb memory with or without ECC		200-pin SO-DIMM socket for one module
	256MB ECC RAM soldered on-board		DDR333 memory
FLASH	CF-Slot		Can be used with any CF Storage Card
RTC	Backed with field exchangeable or external battery		CMOS setup can be saved in EEPROM
Graphics	INTEL IGD (Integrated Graphics Device)		Digital-Video on lockable header 1920 x 1200
Clupinoo	250MHz graphic core with 2D and 3D engine		Analog-Video on lockable header 2048 x 1536
	350MHz, 24-bit RAMDAC		LVDS ports on lockable header, 1920 x 1200
			DVD-I header is ESD protected
Serial Ports	Dual panel support (DVI, LVDS) 2 x RS232 ports with full modem handshake		On ESD protected, lockable header
USB 2.0	4 x ports with up to 480 Mbit/s		On ESD protected, lockable header, bootable
Ethernet	10BaseT /100BaseTX / 1000BaseTX		On ESD protected, lockable header, auto nego.
Parallel Port	SPP, EPP, ECP (IEEE1284)		On ESD protected, lockable header
			•
S-ATA Port	1 port for transfer rates up to 150Mbyte/s		On standard SATA connector
FDD Port	Up to 2.88 MByte FDD supported		Connection over the Parallel Port
PC/104-Plus Interface	8/16 bit memory and I/O ISA Interface (PC/104)		32 bit PCI interface, up to 4 PC/104-Plus cards
Keyboard / Mouse	PS/2 interfaces		On ESD protected, lockable header
Audio Interface	1 stereo output incl. headphone amplifier		On ESD protected, lockable header
	r 2 stages, independent count values for each stage		Configurable granularity from 1µs to 10 min
Power Reset Button	On board / remote power and a remote reset button		ATX functionality, ESD protected
Indicators	Bicolored Power / Reset LED		Signals for external LAN LED on header
Temperature sensor	Monitors CPU, on-board	memory and PCB temperat	ure
Physical / Power			
Size & weight	Footprint: 96mm x 90mm	n (3.8" x 3.6")	as described in PC/104-Plus Specification
	Height: 28.7mm (1.13") v	vithout heat spreader	Weight: 180 g
Mounting	Easy mounting over chromated aluminum heat spreader (96mm x 90mm) with several thread holes		
Power	5VDC supply power (ove	er PC104 or separate plug)	High efficiency switching regulators
Board Data:	Power Consumption	Standard Temperature	Extended Temperature
MIP11	11 – 22W	-20°C to +60°C	-40°C to +65°C
MIP10	11 – 19W	-20°C to +60°C	-40°C to +75°C
MIP9 / MIP8	11 – 15W	-20°C to +60°C	-40°C to +75°C
Measured at 5VDC	Upper value under full sr	eed and full load with 512M	
Humidity	Upper value under full speed and full load with 512MB RAM, Gigabit Link, SATA HD 5% - 95% non condensing		
Standard Compliance			
_		et common standarda. Darti	aular references are:
EMC	e designed to meet the most common standards. Particular references are:		
	EN 55022, EN 55024, EN 61000, MIL-STD-461E		
Shock & Vibration Environmental & Safety	EN 60068 EN 50155, MIL-STD-810-F, EN 60601, EN 60950		
Board Versions	Expansions & Optio	ns	Operating Systems
Complete version	Over the PC/104- <i>Plus</i> :		100% PC/AT compatible and can be oper-
Depopulated versions	Digital or Analog I/O		ated with DOS, Windows, QNX or any other
Coated versions	• Fieldbus (CAN, PROFIBUS,)		PC compatible operation system. Linux dis-
• Extended temp. versions	GigE and switch modules		tributions are available.
Extended temp. versions		0	

The MIP10 family is fully developed, designed and produced by MPLAG in Switzerland. For other requirements contact MPL.



MPL AG, Täfernstrasse 20, CH-5405 Baden-Dättwil Tel. +41 (0)56 483 34 34, Fax +41 (0)56 493 30 20 Email: info@mpl.ch, Home page: www.mpl.ch



MPL AG is an ISO9001 certified company